

P6SMB6.8AT3G Series, SZP6SMB6.8AT3G Series

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Power Dissipation (Note 1) @ $T_L = 25^\circ\text{C}$, Pulse Width = 1 ms	P_{PK}	600	W
DC Power Dissipation @ $T_L = 75^\circ\text{C}$ Measured Zero Lead Length (Note 2) Derate Above 75°C	P_D	3.0 40	W mW/ $^\circ\text{C}$
Thermal Resistance from Junction-to-Lead	$R_{\theta JL}$	25	$^\circ\text{C}/\text{W}$
DC Power Dissipation (Note 3) @ $T_A = 25^\circ\text{C}$ Derate Above 25°C	P_D	0.55 4.4	W mW/ $^\circ\text{C}$
Thermal Resistance from Junction-to-Ambient	$R_{\theta JA}$	226	$^\circ\text{C}/\text{W}$
Forward Surge Current (Note 4) @ $T_A = 25^\circ\text{C}$	I_{FSM}	100	A
Operating and Storage Temperature Range	T_J, T_{stg}	-65 to +150	$^\circ\text{C}$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

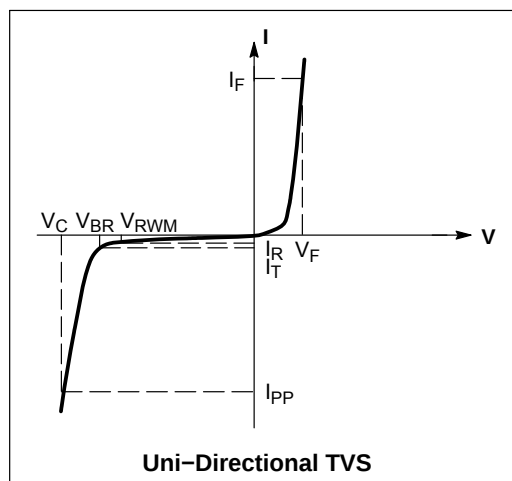
1. 10 X 1000 μs , non-repetitive
2. 1" square copper pad, FR-4 board
3. FR-4 board, using Littelfuse minimum recommended footprint, as shown in 403A case outline dimensions spec.
4. 1/2 sine wave (or equivalent square wave), PW = 8.3 ms, duty cycle = 4 pulses per minute maximum.

ELECTRICAL CHARACTERISTICS

($T_A = 25^\circ\text{C}$ unless otherwise noted, $V_F = 3.5\text{ V Max. @ } I_F$
(Note 4) = 30 A, $V_F = 1.3\text{ V Max. @ } I_F$ (Note 4) = 3 A) (Note 5)

Symbol	Parameter
I_{PP}	Maximum Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}
V_{RWM}	Working Peak Reverse Voltage
I_R	Maximum Reverse Leakage Current @ V_{RWM}
V_{BR}	Breakdown Voltage @ I_T
I_T	Test Current
ΘV_{BR}	Maximum Temperature Coefficient of V_{BR}
I_F	Forward Current
V_F	Forward Voltage @ I_F

5. 1/2 sine wave or equivalent, PW = 8.3 ms, non-repetitive duty cycle



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ELECTRICAL CHARACTERISTICS

Device*	Device Marking	V _{RWM} (Note 6)	I _R @ V _{RWM}	Breakdown Voltage				V _C @ I _{PP} (Note 8)		θV _{BR}	C _{typ} (Note 9)
				V _{BR} V (Note 7)			@ I _T	V _C	I _{PP}		
		V	μA	Min	Nom	Max	mA	V	A	%/°C	pF
P6SMB6.8AT3G	6V8A	5.8	1000	6.45	6.8	7.14	10	10.5	57	0.057	2380
P6SMB7.5AT3G	7V5A	6.4	500	7.13	7.51	7.88	10	11.3	53	0.061	2180
P6SMB8.2AT3G	8V2A	7.02	200	7.79	8.2	8.61	10	12.1	50	0.065	2015
P6SMB9.1AT3G	9V1A	7.78	50	8.65	9.1	9.55	1	13.4	45	0.068	1835
P6SMB10AT3G	10A	8.55	10	9.5	10	10.5	1	14.5	41	0.073	1690
P6SMB12AT3G	12A	10.2	5	11.4	12	12.6	1	16.7	36	0.078	1435
P6SMB13AT3G	13A	11.1	5	12.4	13.05	13.7	1	18.2	33	0.081	1335
P6SMB15AT3G	15A	12.8	5	14.3	15.05	15.8	1	21.2	28	0.084	1175
P6SMB16AT3G	16A	13.6	5	15.2	16	16.8	1	22.5	27	0.086	1110
P6SMB18AT3G	18A	15.3	5	17.1	18	18.9	1	25.2	24	0.088	1000
P6SMB20AT3G	20A	17.1	5	19	20	21	1	27.7	22	0.09	910
P6SMB22AT3G	22A	18.8	5	20.9	22	23.1	1	30.6	20	0.092	835
P6SMB24AT3G	24A	20.5	5	22.8	24	25.2	1	33.2	18	0.094	775
P6SMB27AT3G	27A	23.1	5	25.7	27.05	28.4	1	37.5	16	0.096	700
P6SMB30AT3G	30A	25.6	5	28.5	30	31.5	1	41.4	14.4	0.097	635
P6SMB33AT3G	33A	28.2	5	31.4	33.05	34.7	1	45.7	13.2	0.098	585
P6SMB36AT3G	36A	30.8	5	34.2	36	37.8	1	49.9	12	0.099	540
P6SMB39AT3G	39A	33.3	5	37.1	39.05	41	1	53.9	11.2	0.1	500
P6SMB43AT3G	43A	36.8	5	40.9	43.05	45.2	1	59.3	10.1	0.101	460
P6SMB47AT3G	47A	40.2	5	44.7	47.05	49.4	1	64.8	9.3	0.101	425
P6SMB51AT3G	51A	43.6	5	48.5	51.05	53.6	1	70.1	8.6	0.102	395
P6SMB56AT3G	56A	47.8	5	53.2	56	58.8	1	77	7.8	0.103	365
P6SMB62AT3G	62A	53	5	58.9	62	65.1	1	85	7.1	0.104	335
P6SMB68AT3G	68A	58.1	5	64.6	68	71.4	1	92	6.5	0.104	305
P6SMB75AT3G	75A	64.1	5	71.3	75.05	78.8	1	103	5.8	0.105	280
P6SMB91AT3G	91A	77.8	5	86.5	91	95.5	1	125	4.8	0.106	235
P6SMB100AT3G	100A	85.5	5	95	100	105	1	137	4.4	0.106	215
P6SMB120AT3G	120A	102	5	114	120	126	1	165	3.6	0.107	185
P6SMB130AT3G	130A	111	5	124	130.5	137	1	179	3.3	0.107	170
P6SMB150AT3G	150A	128	5	143	150.5	158	1	207	2.9	0.108	150
P6SMB160AT3G	160A	136	5	152	160	168	1	219	2.7	0.108	140
P6SMB180AT3G	180A	154	5	171	180	189	1	246	2.4	0.108	130
P6SMB200AT3G	200A	171	5	190	200	210	1	274	2.2	0.108	115

6. A transient suppressor is normally selected according to the working peak reverse voltage (V_{RWM}), which should be equal to or greater than the DC or continuous peak operating voltage level.

7. V_{BR} measured at pulse test current I_T at an ambient temperature of 25°C.

8. Surge current waveform per Figure 2 and derate per Figure 3.

9. Bias Voltage = 0 V, F = 1 MHz, T_J = 25°C

* Include SZ-prefix devices where applicable.

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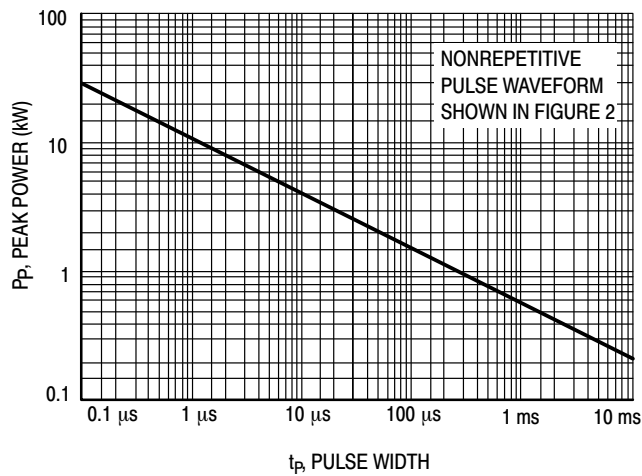


Figure 1. Pulse Rating Curve

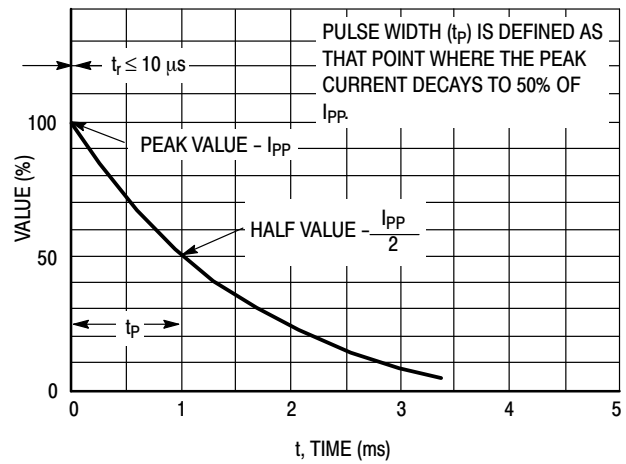


Figure 2. Pulse Waveform

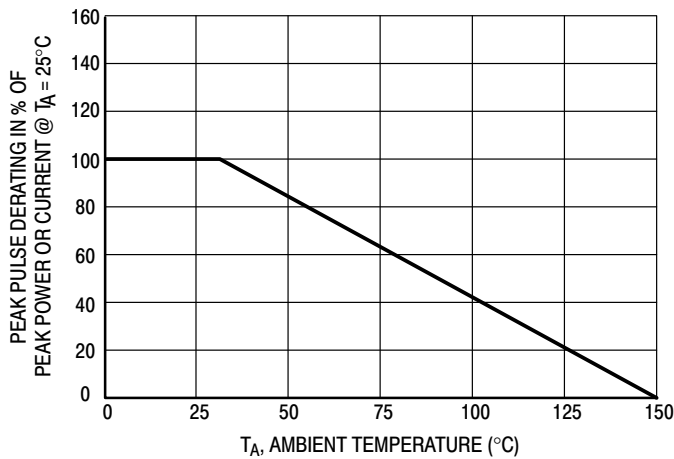


Figure 3. Pulse Derating Curve

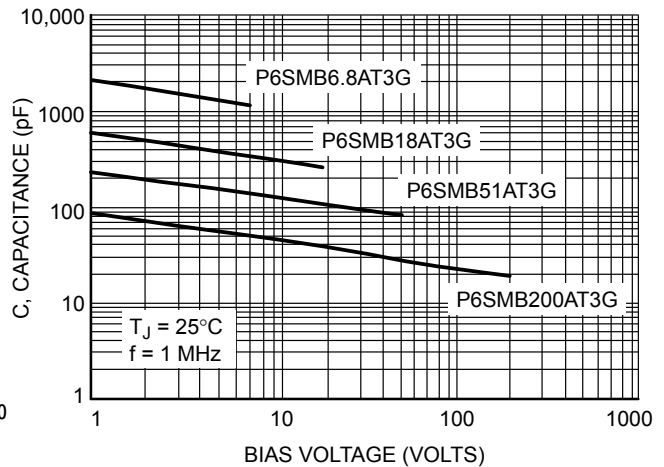
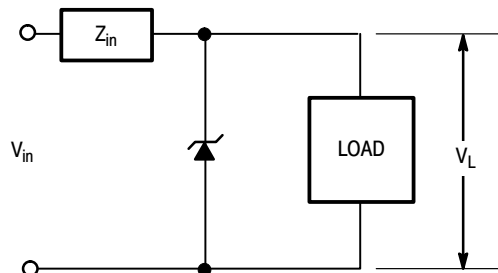


Figure 4. Typical Junction Capacitance vs. Bias Voltage

TYPICAL PROTECTION CIRCUIT



APPLICATION NOTES

Response Time

In most applications, the transient suppressor device is placed in parallel with the equipment or component to be protected. In this situation, there is a time delay associated with the capacitance of the device and an overshoot condition associated with the inductance of the device and the inductance of the connection method. The capacitive effect is of minor importance in the parallel protection scheme because it only produces a time delay in the transition from the operating voltage to the clamp voltage as shown in Figure 5.

The inductive effects in the device are due to actual turn-on time (time required for the device to go from zero current to full current) and lead inductance. This inductive effect produces an overshoot in the voltage across the equipment or component being protected as shown in Figure 6. Minimizing this overshoot is very important in the application, since the main purpose for adding a transient suppressor is to clamp voltage spikes. The SMB series have a very good response time, typically < 1 ns and negligible inductance. However, external inductive effects could produce unacceptable overshoot. Proper circuit layout,

minimum lead lengths and placing the suppressor device as close as possible to the equipment or components to be protected will minimize this overshoot.

Some input impedance represented by Z_{in} is essential to prevent overstress of the protection device. This impedance should be as high as possible, without restricting the circuit operation.

Duty Cycle Derating

The data of Figure 1 applies for non-repetitive conditions and at a lead temperature of 25°C. If the duty cycle increases, the peak power must be reduced as indicated by the curves of Figure 7. Average power must be derated as the lead or ambient temperature rises above 25°C. The average power derating curve normally given on data sheets may be normalized and used for this purpose.

At first glance the derating curves of Figure 7 appear to be in error as the 10 ms pulse has a higher derating factor than the 10 μ s pulse. However, when the derating factor for a given pulse of Figure 7 is multiplied by the peak power value of Figure 1 for the same pulse, the results follow the expected trend.

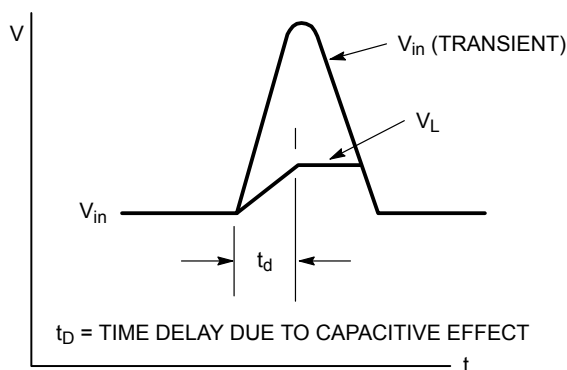


Figure 5.

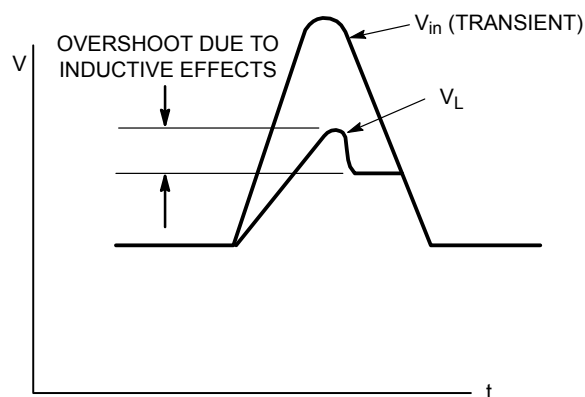


Figure 6.

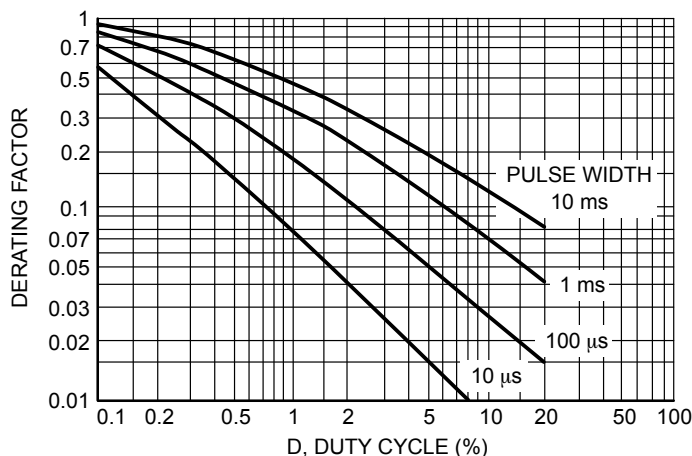


Figure 7. Typical Derating Factor for Duty Cycle

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UL RECOGNITION

The entire series has *Underwriters Laboratory Recognition* for the classification of protectors (QVGQ2) under the UL standard for safety 497B and File #E128662. Many competitors only have one or two devices recognized or have recognition in a non-protective category. Some competitors have no recognition at all. With the UL497B recognition, our parts successfully passed several tests

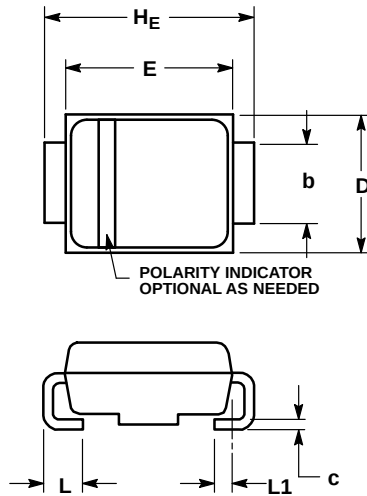
including Strike Voltage Breakdown test, Endurance Conditioning, Temperature test, Dielectric Voltage-Withstand test, Discharge test and several more.

Whereas, some competitors have only passed a flammability test for the package material, we have been recognized for much more to be included in their Protector category.

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PACKAGE DIMENSIONS

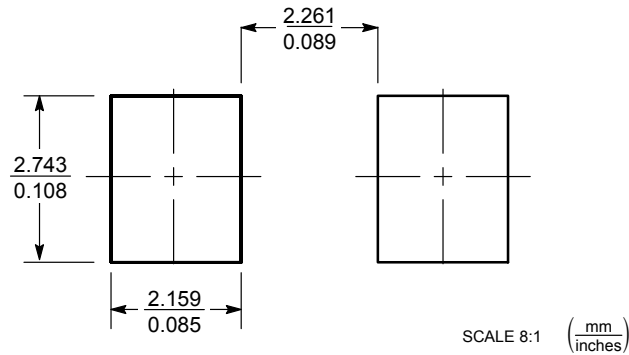
SMB CASE 403A-03 ISSUE J



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION b SHALL BE MEASURED WITHIN DIMENSION L1.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.95	2.30	2.47	0.077	0.091	0.097
A1	0.05	0.10	0.20	0.002	0.004	0.008
b	1.96	2.03	2.20	0.077	0.080	0.087
c	0.15	0.23	0.31	0.006	0.009	0.012
D	3.30	3.56	3.95	0.130	0.140	0.156
E	4.06	4.32	4.60	0.160	0.170	0.181
HE	5.21	5.44	5.60	0.205	0.214	0.220
L	0.76	1.02	1.60	0.030	0.040	0.063
L1	0.51 REF			0.020 REF		

SOLDERING FOOTPRINT



Littelfuse products are not designed for, and shall not be used for, any purpose (including, without limitation, automotive, military, aerospace, medical, life-saving, life-sustaining or nuclear facility applications, devices intended for surgical implant into the body, or any other application in which the failure or lack of desired operation of the product may result in personal injury, death, or property damage) other than those expressly set forth in applicable Littelfuse product documentation. Warranties granted by Littelfuse shall be deemed void for products used for any purpose not expressly set forth in applicable Littelfuse documentation. Littelfuse shall not be liable for any claims or damages arising out of products used in applications not expressly intended by Littelfuse as set forth in applicable Littelfuse documentation. The sale and use of Littelfuse products is subject to Littelfuse Terms and Conditions of Sale, unless otherwise agreed by Littelfuse.